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PCN Issue Date: 11/22/2016		Effective Date: 2/28/2017				
Title: Si301X-F-XM 3x3QFN Change of Die Attach Film (DAF) material supplier in ASECL						
РСМ Туре:						
Datasheet	□ Foundry	□ Packing				
Product Revision	Assembly	□ Labeling				
Discontinuance	□ Test	□ Other				
Last Order Date: NA						
PCN Details						
Description of Change:						
Silicon Labs is pleased to announce the successful qualification of a new die attach film (DAF) supplier, HENKEL, as part of a new BOM for Si301X-F-XM (3x3 QFN) devices in ASECL assembly site.						
Item	Current DAF	Proposed new DAF				
Material name	EM-550-P-H	ATB-125HA2				
Supplier	Nitto	Henkel				
Liner	38um	38um				
Die attach film	25um	25um				

Reason for Change:

Current supplier, NITTO, will be discontinuing the production of die attach film, EM series, in Q1'17. This PCN is required to qualify a new supplier for die attach film.

Impact on Form, Fit, Function, Quality, Reliability:

There is no impact on form, fit, function, quality and reliability. The Si301X-F-XM devices manufactured/assembled using the new die attach film will fully comply with datasheet parameters and quality levels.

Product Identification:

Affected Device					
Si3011-F-FM	Si3011-F-FMR				
Si3018-F-FM	Si3018-F-FMR				
Si3019-F-GM	Si3019-F-GMR				
Si3019-F-FM	Si3019-F-FMR				

Last Date of Unchanged Product: 2/28/2017

Qualification Samples:

Available upon request. Please contact your local Silicon Labs sales representative to order samples.

W7206F1 Process Change Notice Form rev AAB

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Specific conditions of acceptance of this change will be considered on a case by case basis if written notice is submitted within 30 days of this notice. To request further data or inquire about this notification, please contact your local Silicon Labs sales representative. A list of Silicon Labs sales representatives is available at <u>www.silabs.com</u>.

In some cases rejection of a change notice may impact Silicon Labs product pricing, delivery, quality, or reliability.

Customer Early Acceptance Sign Off:

Customers may approve early PCN acceptance by completing the information below:

Early Acceptance: Date: _____

Name:

Company:

Email your early Acceptance approval to: <u>katherine.haggar@silabs.com</u>

Qualification Data:

Please see Appendix.



Appendix

Si301x 20-QFN-3x3 ASECL Qualification Report



W7101F1 - Product Qualification Report Record Rev. I

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Part Rev F, V	Part Rev F, VIS Fabrication, ASECL Assembly							
Test Name	Test Condition	Qualification	Lot ID or Start	Fail/Pass or End	Notes	Summary	Status	
Test Group A – A	Accelerated Environment Stres	sTests						
HAST	JA110		Q029292	0/77	2			
	130°C, 85%RH	3 lots, N=>25	Q029359	0/77	2	3 lots	Pass	
	Vcc=3.6V, 96 hours		Q029318	0/77	2	0/231		
UHAST	JA118		Q040291	0/77	1			
	130°C, 85%RH	3 lots, N=>25	Q040292	0/77	1	3 lots	Pass	
	96 hours		Q040293	0/77	1	0/231		
Temp Cycle	JA104		Q040318	0/77	1			
	Cond C: -65°C to 150°C	3 lots, N=>25	Q040319	0/77	1	3 lots	Pass	
	500 cycles		Q040320	0/77	1	0/231		
HTSL	JA103		Q029295	0/77	2			
	150°C, 1000hr	3 lots, N=>25	Q029299	0/77	2	3 lots	Pass	
			Q029303	0/77	2	0/231		

Notes:

1. Parts are Pre-conditioned at MSL2/260°C

2. Parts are Pre-conditioned at MSL1/260°C

This report applies to the following part numbers:				
SI3011-F-FM				
SI 301 8-F-FM				
SI 301 9-F-FM				
SI 301 9-F-GM				

Prepared on: 16-Nov-16

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